

32K x 8 Power Switched and Reprogrammable PROM

Features

- CMOS for optimum speed/power
- Windowed for reprogrammability
- High speed
 - 30 ns (Commercial)
- 35 ns (Military)
- · Low power
 - 660 mW (commercial)
 - 715 mW (military)
- Super low standby power
- Less than 165 mW when deselected
- EPROM technology 100% programmable
- Slim 300-mil package (7C271)
- Direct replacement for bipolar PROMs
- Capable of withstanding >2001V static discharge

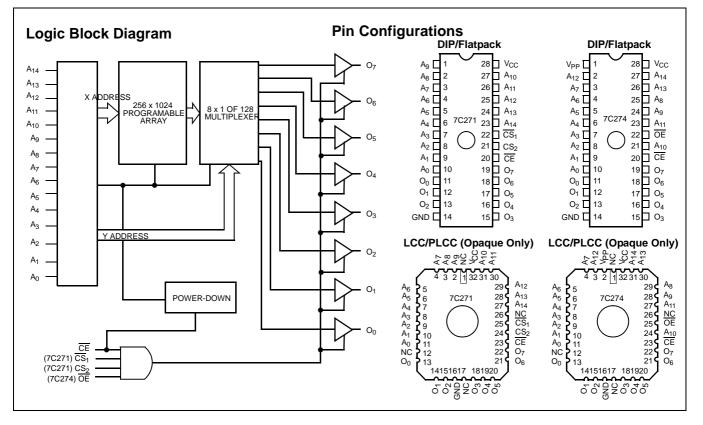
Functional Description

The CY7C271 and CY7C274 are high-performance 32,768-word by 8-bit CMOS PROMs. When disabled (CE HIGH), the 7C271/7C274 automatically powers down into a

low-power stand-by mode. The CY7C271 is packaged in the 300-mil slim package. The CY7C274 is packaged in the industry standard 600-mil package. Both the CY7C271 and CY7C274 are available in a cerDIP package equipped with an erasure window to provide for reprogrammability. When exposed to UV light, the PROM is erased and can be reprogrammed. The memory cells utilize proven EPROM floating gate technology and byte-wide intelligent programming algorithms.

The CY7C271 and CY7C274 offer the advantage of lower power, superior performance, and programming yield. The EPROM cell requires only 12.5V for the super voltage, and low current requirements allow for gang programming. The EPROM cells allow each memory location to be tested 100% because each location is written into, erased, and repeatedly exercised prior to encapsulation. Each PROM is also tested for AC performance to guarantee that after customer programming, the product will meet DC and AC specification limits.

Reading th<u>e</u> 7C271<u>is</u> accomplished by placing active LOW signals on CS₁ and CE, and an active HIGH on CS₂. Reading the <u>7C</u>274 is accomplished by placing active LOW signals on OE and CE. The contents of the memory location addressed by the address lines (A₀-A₁₄) will become available on the output lines (O₀-O₇).



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San Jose, CA 95134-1709 • 408-943-2600 Revised August 17, 2006



Selection Guide

		7C274-30	7C271-35 7C274-35	7C271-45 7C274-45	7C271-55	Unit
Maximum Access Time		30	35	45	55	ns
Maximum Operating	Com'l	120	120	120	120	mA
Current	Military		130	130	130	mA
Standby Current	Com'l	30	30	30	30	mA
	Military		40	40	40	mA

Maximum Ratings^[1]

(Above which the useful life may be impaired. For user guide- lines, not tested.)	•
Storage Temperature65°C to +150°C	
Ambient Temperature with Power Applied55°C to +125°C	
Supply Voltage to Ground Potential0.5V to +7.0V	
DC Voltage Applied to Outputs in High Z State0.5V to +7.0V	
DC Input Voltage3.0V to +7.0V	
DC Program Voltage	

Static Discharge Voltage.....>2001V (per MIL-STD-883, Method 3015) Latch-Up Current.....>200 mA

Operating Range

Range	Ambient Temperature	V _{cc}
Commercial	0°C to +70°C	5V ±10%
Military ^[2]	–55°C to +125°C	5V ±10%

Electrical Characteristics Over the Operating Range^[3]

					35, 45, 55 0, 35, 45,	
Parameter	Description	Test Conditio	ons	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V_{CC} = Min., I_{OH} = -2.0 mA		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA ^[4]			0.4	V
V _{IH}	Input HIGH Level	Guaranteed Input Logical HIC Inputs	GH Voltage for All	2.0	V _{CC}	V
V _{IL}	Input LOW Level	Guaranteed Input Logical LOW Voltage for All Inputs			0.8	V
I _{IX}	Input Current	$GND \le V_{IN} \le V_{CC}$		-10	+10	μA
I _{OZ}	Output Leakage Current	$GND \leq V_{OUT} \leq V_{CC}$, Output Disabled		-40	+40	μA
I _{OS}	Output Short Circuit Current ^[5]	V _{CC} = Max., V _{OUT} = GND		-20	-90	mA
I _{CC}	Power Supply Current	V _{CC} = Max., V _{IN} = 2.0V,	Commercial		120	mA
		$I_{OUT} = 0 \text{ mA}, CE = V_{IL}$	Military		130	
I _{SB}	Standby Supply Current	$V_{CC} = Max., \overline{CE} = V_{IH},$	Commercial		30	mA
		I _{OUT} = 0 mA	Military		40	
V _{PP}	Programming Supply Voltage		- 1	12	13	V
I _{PP}	Programming Supply Current				50	mA

Notes

The voltage on any input or I/O pin cannot exceed the power pin during power-up.
T_A is the "instant on" case temperature.
See the last page of this specification for Group A subgroup testing information.

4. 6.0 mA military

5. For test purposes, not more than one output at a time should be shorted. Short circuit test duration should not exceed 30 seconds.

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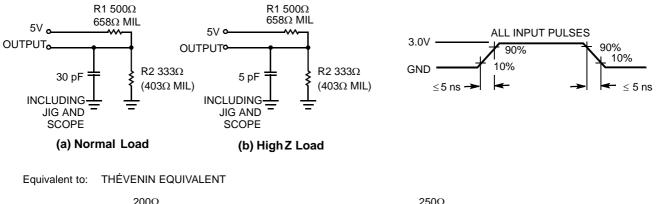
Electrical Characteristics Over the Operating Range^[3]

			7C271- 35, 45, 55 7C274-30, 35, 45,		
Parameter	Description	Test Conditions	Min.	Max.	Unit
V _{IHP}	Input HIGH Programming Voltage		3.0		V
V _{ILP}	Input LOW Programming Voltage			0.4	V

Capacitance^[6]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_{A} = 25^{\circ}C, f = 1 \text{ MHz},$	10	pF
C _{OUT}	Output Capacitance	$V_{CC} = 5.0V$	10	pF

AC Test Loads and Waveforms^[6]



200Ω			250Ω	
	2.00V COMMERCIAL	OUTPUT •		1.90V MILITARY

Note

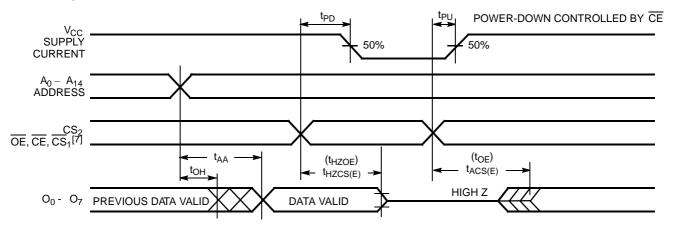
6. See Introduction to CMOS PROMs for general information on testing.



Switching Characteristics Over the Operating Range^[3,6]

		7C274-30				7C271-35 7C271-45 7C274-35 7C274-45		7C271-55		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t _{AA}	Address to Output Valid		30		35		45		55	ns
t _{HZCS}	Chip Select Inactive to High Z (\overline{CS}_1 and CS_2 , 7C271 Only)		20		25		30		30	ns
t _{ACS}	Chip Select Active to Output Valid (\overline{CS}_1 and CS_2 , 7C271 Only)		20		25		30		30	ns
t _{HZOE}	Output Enable Inactive to High Z (OE, 7C274 Only)		20		20		25		25	ns
t _{OE}	Output Enable Active to Output Valid (OE, 7C274 Only)		20		20		25		25	ns
t _{HZCE}	Chip Enable Inactive to High Z (CE Only)		35		40		50		60	ns
t _{ACE}	Chip Enable Active to Output Valid (CE Only)		35		40		50		60	ns
t _{PU}	Chip Enable Active to Power Up	0		0		0		0		ns
t _{PD}	Chip Enable Inactive to Power Down		35		40		50		60	ns
t _{OH}	Output Hold from Address Change	0		0		0		0		ns

Switching Waveform



Erasure Characteristics

Wavelengths of light less than 4000 angstroms begin to erase the CY7C271 and CY7C274 in the windowed package. For this reason, an opaque label should be placed over the window if the PROM is exposed to sunlight or fluorescent lighting for extended periods of time.

The recommended dose of ultraviolet light for erasure is a wavelength of 2537 angstroms for a minimum dose (UV intensity \times exposure time) of 25 Wsec/cm². For an ultraviolet lamp with a 12 mW/cm² power rating, the exposure time would be approximately 35 minutes. The CY7C271 or CY7C274 needs to be within 1 inch of the lamp during erasure. Permanent damage may result if the

Note 7. CS_2 and \overline{CS}_1 are used on the 7C271 only. \overline{OE} is used on the 7C274 only.

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PROM is exposed to high-intensity UV light for an extended period of time. 7258 $\rm Wsec/cm^2$ is the recommended maximum dosage.

Programming Modes

Programming support is available from Cypress as well as from a number of third-party software vendors. For detailed programming information, including a listing of software packages, please see the PROM Programming Information located at the end of this section. Programming algorithms can be obtained from any Cypress representative.



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Table 1. CY7C271 Mode Selection

				Pin Function ^{[8}	8]	
	Read or Output Disable	A ₁₄ -A ₀	CE	CS ₂	CS ₁	O ₇ O ₀
Mode	Other	A ₁₄ -A ₀	VFY	PGM	V _{PP}	D ₇ -D ₀
Read		A ₁₄ A ₀	V _{IL}	V _{IH}	V _{IL}	O ₇ -O ₀
Power Dow	n	A ₁₄ A ₀	V _{IH}	Х	Х	High Z
Output Disa	ble	A ₁₄ A ₀	Х	V _{IL}	Х	High Z
Output Disa	ble	A ₁₄ A ₀	Х	Х	V _{IH}	High Z
Program		A ₁₄ A ₀	V _{IHP}	V _{ILP}	V _{PP}	D7-D0
Program Ve	rify	A ₁₄ A ₀	V _{ILP}	V _{IHP} /V _{ILP}	V _{PP}	0 ₇ -0 ₀
Program Inf	nibit	A ₁₄ A ₀	V _{IHP}	V _{IHP}	V _{PP}	High Z
Blank Chec	k	A ₁₄ A ₀	V _{ILP}	V _{IHP} /V _{ILP}	V _{PP}	0 ₇ -0 ₀

Table 2. CY7C274 Mode Selection

				Pin Function	8]	
	Read or Output Disable	A ₁₄ -A ₀	OE	CE	V _{PP}	0 ₇ –0 ₀
Mode	Other	A ₁₄ –A ₀	VFY	PGM	V _{PP}	D7-D0
Read		A ₁₄ A ₀	VIL	V _{IL}	Note 9	O ₇ -O ₀
Output Disa	ble	A ₁₄ A ₀	V _{IH}	Х	Х	High Z
Power Down	n	A ₁₄ A ₀	Х	V _{IH}	Х	High Z
Program		A ₁₄ A ₀	V _{IHP}	V _{ILP}	V _{PP}	D7-D0
Program Ve	rify	A ₁₄ A ₀	V _{ILP}	V _{IHP} /V _{ILP}	V _{PP}	O ₇ -O ₀
Program Inh	nibit	A ₁₄ A ₀	V _{IHP}	V _{IHP}	V _{PP}	High Z
Blank Checl	k	A ₁₄ A ₀	V _{ILP}	V _{IHP} /V _{ILP}	V _{PP}	O ₇ -O ₀

 $\begin{array}{l} \textbf{Notes} \\ \textbf{8.} \quad \textbf{X} \mbox{ can be } V_{IL} \mbox{ (V}_{ILP}) \mbox{ or } V_{IH} \mbox{ (V}_{IHP).} \\ \textbf{9.} \quad V_{PP} \mbox{ should be tied to } V_{CC} \pm 5\% \mbox{ in read mode.} \end{array}$



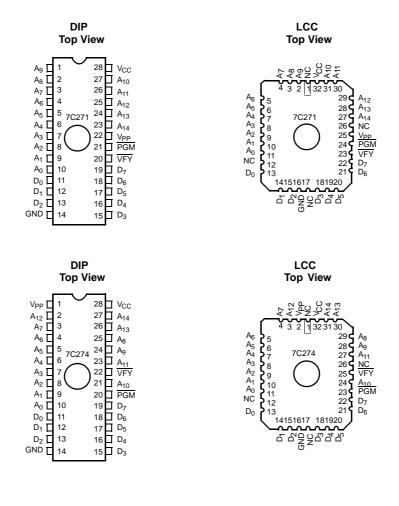


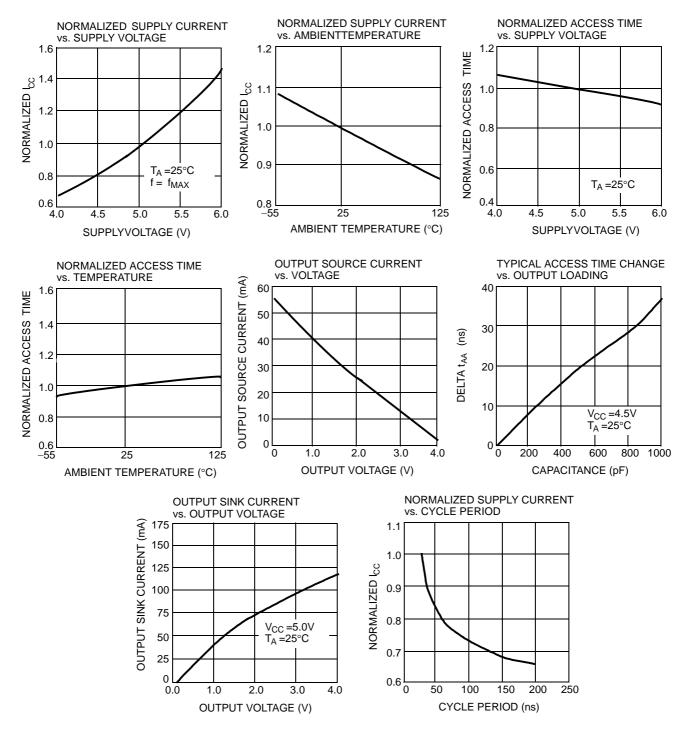
Figure 1. Programming Pinouts

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Typical DC and AC Characteristics



C271-14



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Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
35	CY7C271-35WMB	W22	28-Lead (300-Mil) Windowed CerDIP	Military
45	CY7C271-45WMB	W22	28-Lead (300-Mil) Windowed CerDIP	Military
	CY7C274-45WMB	W16	28-Lead (600-Mil) Windowed CerDIP	
55	CY7C271-55WMB	W22	28-Lead (300-Mil) Windowed CerDIP	Military

MILITARY SPECIFICATIONS Group A Subgroup Testing

DC Characteristics

Parameter	Subgroups
V _{OH}	1, 2, 3
V _{OL}	1, 2, 3
V _{IH}	1, 2, 3
V _{IL}	1, 2, 3
I _{IX}	1, 2, 3
I _{OZ}	1, 2, 3
I _{CC}	1, 2, 3
I _{SB}	1, 2, 3

Switching Characteristics

Parameter	Subgroups
t _{AA}	7, 8, 9, 10, 11
t _{ACS} ^[10]	7, 8, 9, 10, 11
t _{OE} ^[11]	7, 8, 9, 10, 11
t _{ACE}	7, 8, 9, 10, 11

SMD Cross Reference

SMD Number	Suffix	Cypress Number
5962-89817	01ZX	CY7C271-55QMB
5962-89817	02XX	CY7C271-45WMB
5962-89817	02ZX	CY7C271-45QMB

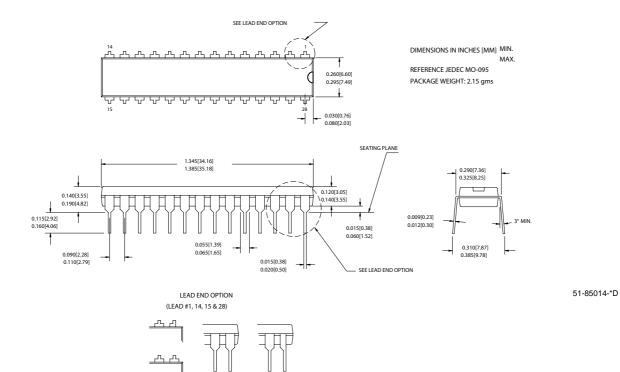
Notes 10. 7C271 only (\overline{CS}_1 and CS_2). 11. 7C274 only.

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Package Diagrams Figure 2. 28-Lead (300-Mil) PDIP P21

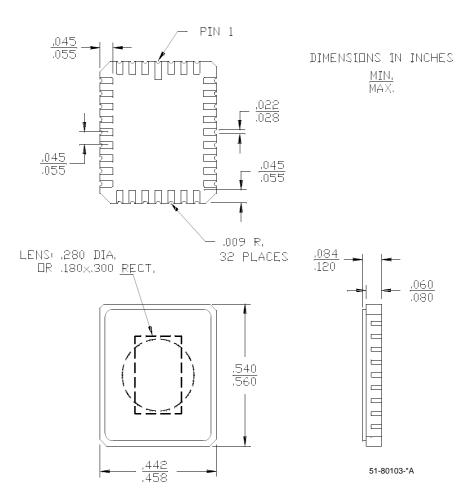




Package Diagrams (continued)

Figure 3. 32-Pin Windowed Rectangular Leadless Chip Carrier Q55

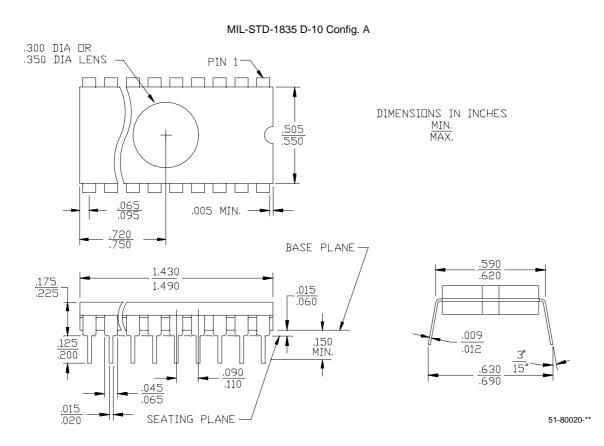
MIL-STD-1835 C-12





Package Diagrams (continued)

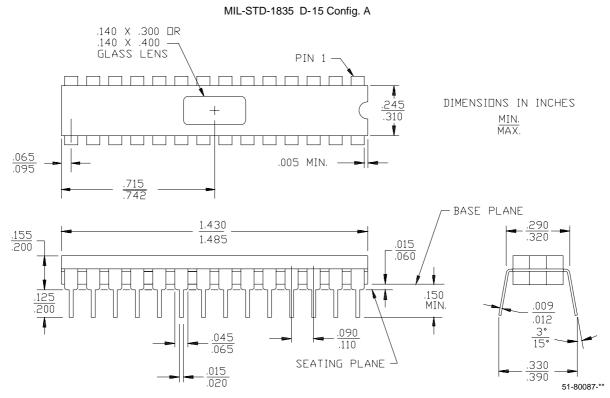
Figure 4. 28-Lead (600-Mil) Windowed CerDIP W16





Package Diagrams (continued)

Figure 5. 28-Lead (300-Mil) Windowed CerDIP W22



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Document History Page

Document Title: CY7C271 CY7C274 32K x 8 Power Switched and Reprogrammable PROM Document Number: 38-04008					
REV.	ECN NO.	lssue Date	Orig. of Change	Description of Change	
**	113864	3/8/02	DSG	Changed from Spec number: 38-00068 to 38-04008	
A*	118899	10/10/02	GBI	Updated Ordering Information	
*В	122249	12/27/02	RBI	Added power up requirements to Operating Conditions information	
*C	499542	See ECN	PCI	Updated Ordering Information	